

SUBMINIATURE SOLID STATE LAMP

Part Number: AM2520EF/4ID

High Efficiency Red

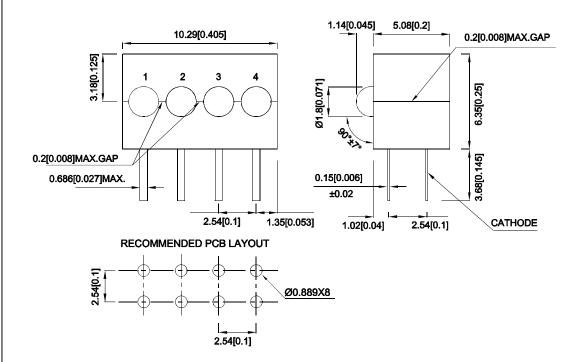
Features

- Black case enhances contrast.
- Vibration and shock resistant.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- RoHS compliant.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.

 4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

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Selection Guide

| Part No. | Emitting Color (Material) | Lens Type | lv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|--------------|---------------------------------|---------------|------------------------|------|----------------------|
| | | | Min. | Тур. | 201/2 |
| AMOSOOFE/AID | High Efficiency Dod (CoAsD(CoD) | Dad Differend | 12 | 20 | 40° |
| AM2520EF/4ID | High Efficiency Red (GaAsP/GaP) | Red Diffused | *8 | *16 | |

Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.
- *Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

| Electrical 7 Optical Characteristics at 1A 20 0 | | | | | | | | | |
|---|--------------------------|---------------------|------|------|-------|--------------------|--|--|--|
| Symbol | Parameter | Emitting Color | Тур. | Max. | Units | Test Conditions | | | |
| λpeak | Peak Wavelength | High Efficiency Red | 627 | | nm | IF=20mA | | | |
| λD [1] | Dominant Wavelength | High Efficiency Red | 617 | | nm | IF=20mA | | | |
| Δλ1/2 | Spectral Line Half-width | High Efficiency Red | 45 | | nm | IF=20mA | | | |
| С | Capacitance | High Efficiency Red | 15 | | pF | VF=0V;f=1MHz | | | |
| VF [2] | Forward Voltage | High Efficiency Red | 2 | 2.5 | V | IF=20mA | | | |
| lr | Reverse Current | High Efficiency Red | | 10 | uA | V _R =5V | | | |

Notes:

- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

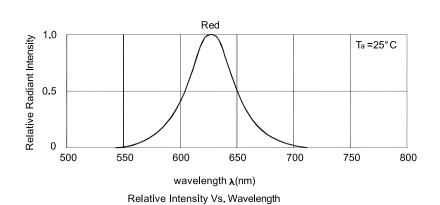
Absolute Maximum Ratings at TA=25°C

| Parameter | Values | Units | | |
|---------------------------------|---------------------|----------------|--|--|
| Power dissipation | 75 | mW | | |
| DC Forward Current | 30 | mA | | |
| Peak Forward Current [1] | 160 | mA | | |
| Reverse Voltage | 5 | V | | |
| Operating / Storage Temperature | -40°C To +85°C | -40°C To +85°C | | |
| Lead Solder Temperature [2] | 260°C For 3 Seconds | | | |
| Lead Solder Temperature [3] | 260°C For 5 Seconds | | | |

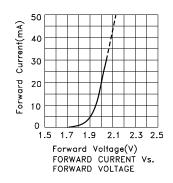
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. 2mm below package base.
 3. 5mm below package base.

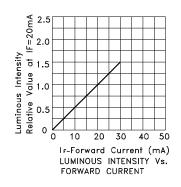
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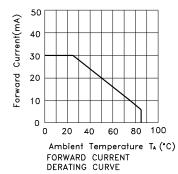
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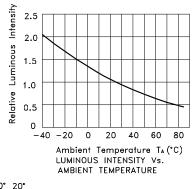


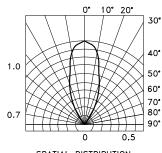
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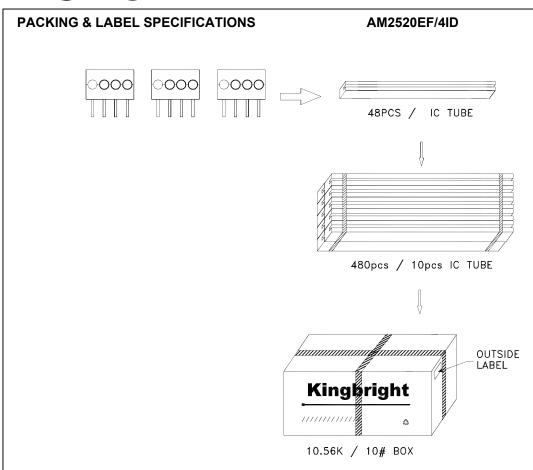


SPATIAL DISTRIBUTION

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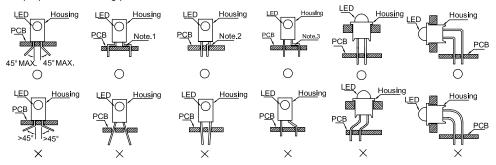
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PRECAUTIONS

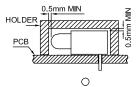
- 1. Storage conditions:
 - a. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
 - b.LEDs should be stored with temperature ≤30°C and relative humidity < 60%.
 - c.Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (\pm 10/-0) hours at 85 ~ 100°C.
- 2. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

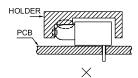


" \bigcirc " Correct mounting method " imes " Incorrect mounting method

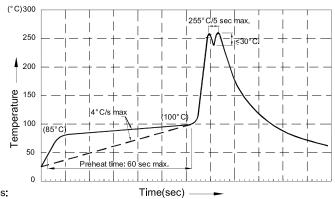
Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.





- 4. The tip of the soldering iron should never touch the lens epoxy.
- 5. Through-hole LEDs are incompatible with reflow soldering.
- If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 7. Recommended Wave Soldering Profiles:



- 1.Recommend pre-heat temperature of 105° C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260° C
- 2.Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above 85°C.
- 4. Fixtures should not incur stress on the component when mounting and during soldering process.
- 5.SAC 305 solder alloy is recommended.
- 6.No more than one wave soldering pass.

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